

X24C02 2K 256 x 8 Bit

# Serial E<sup>2</sup>PROM

## **FEATURES**

- 2.7V to 5.5V Power Supply
- Low Power CMOS
  - -Active Current Less Than 1 mA
- —Standby Current Less Than 50  $\propto$  A •Internally Organized 256 x 8
- •Self Timed Write Cycle
  - —Typical Write Cycle Time of 5 ms
- •2 Wire Serial Interface
  - -Bidirectional Data Transfer Protocol
- •Four Byte Page Write Operation
  - -Minimizes Total Write Time Per Byte
- High Reliability
  - -Endurance: 100.000 Cycles
  - -Data Retention: 100 Years
- •New Hardwire—Write Control Function

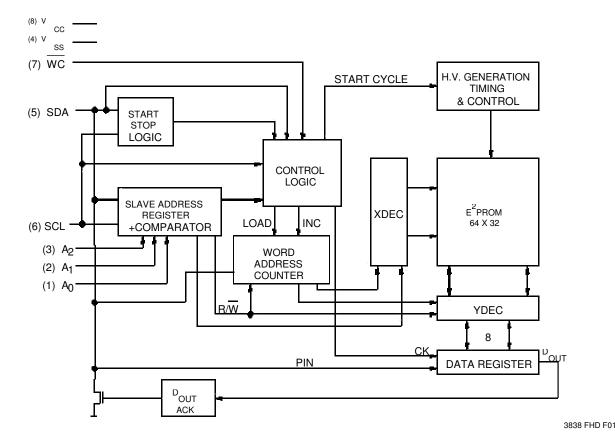
## **DESCRIPTION**

The X24C02 is CMOS a 2048 bit serial E<sup>2</sup>PROM, internally organized 256 x 8. The X24C02 features a serial interface and software protocol allowing operation on a simple two wire bus. Three address inputs allow up to eight devices to share a common two wire bus.

Xicor E<sup>2</sup>PROMs are designed and tested for applications requiring extended endurance. Inherent data

retention is greater than 100 years. Available in DIP, MSOP and SOIC packages.

## **FUNCTIONAL DIAGRAM**



## **PIN DESCRIPTIONS**

#### Serial Clock (SCL)

The SCL input is used to clock all data into and out of the device.

#### Serial Data (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs.

An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the Guidelines for Calculating Typical Values of Bus Pull-Up Resistors graph.

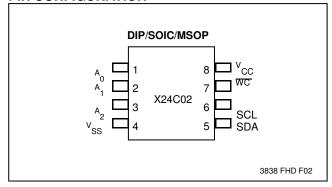
#### Address (A<sub>0</sub>, A<sub>1</sub>, A<sub>2</sub>)

The address inputs are used to set the least significant three bits of the seven bit slave address. These inputs can be static or actively driven. If used statically they must be tied to  $V_{SS}$  or  $V_{CC}$  as appropriate. If actively driven, they must be driven to  $V_{SS}$  or to  $V_{CC}$ .

#### Write Control (WC)

The Write Control input controls the ability to write to the device. When WC is LOW (tied to  $V_{SS}$ ) the X24C02 will be enabled to perform write operations. When WC is HIGH (tied to  $V_{CC}$ ) the internal high voltage circuitry will be disabled and all writes will be disabled.

## PIN CONFIGURATION



#### PIN DESCRIPTIONS

Symbol	Description
A <sub>0</sub> -A <sub>2</sub>	Address Inputs
SDA	Serial Data
SCL	Serial Clock
WC	Write Control
$V_{SS}$	Ground
V <sub>CC</sub>	+5V

3838 PGM T01

## **DEVICE OPERATION**

The X24C02 supports a bidirectional bus oriented protocol The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the X24C02 will be considered a slave in all applications.

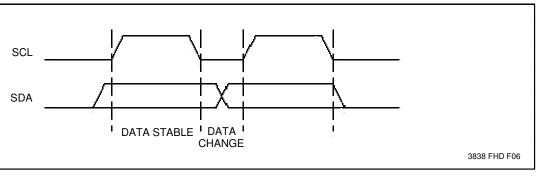
#### **Clock and Data Conventions**

Data states on the SDA line can change only during SCL LOW. SDA state changes during SCL HIGH are reserved for indicating start and stop conditions. Refer to Figures 1 and 2.

#### **Start Condition**

All commands are preceded by the start condition, which is a HIGH to LOW transition of SDA when SCL is HIGH. The X24C02 continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition has been met.

Figure 1. Data Validity



#### **Stop Condition**

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA when SCL is HIGH. The stop condition is also used by the X24C02 to place the device in the standby power mode after a read sequence. A stop condition can only be issued after the transmitting device has released the bus.

#### **Acknowledge**

Acknowledge is a software convention used to indicate successful data transfer. The transmitting device, either master or slave, will release the bus after transmitting eight bits. During the ninth clock cycle the receiver will

pull the SDA line LOW to acknowledge that it received the eight bits of data. Refer to Figure 3.

The X24C02 will respond with an acknowledge after recognition of a start condition and its slave address. If both the device and a write operation have been selected, the X24C02 will respond with an acknowledge after the receipt of each subsequent eight bit word.

In the read mode the X24C02 will transmit eight bits of data release the SDA line and monitor the line for an acknowledge. If an acknowledge is detected and no stop condition is generated by the master, the X24C02 will continue to transmit data. If an acknowledge is not detected, the X24C02 will terminate further data transmissions. The master must then issue a stop condition to return the X24C02 to the standby power mode and place the device into a known state.

Figure 2. Definition of Start and Stop

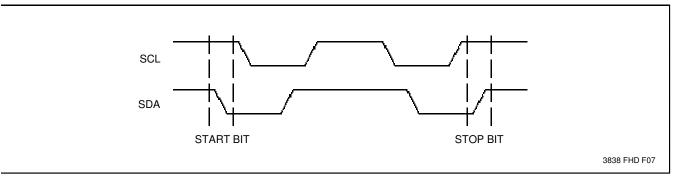
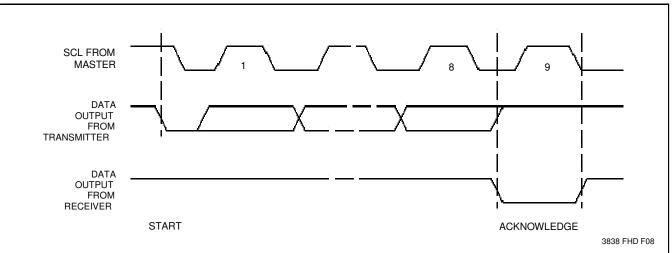


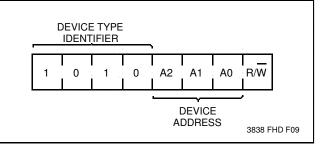
Figure 3. Acknowledge Response From Receiver



#### **DEVICE ADDRESSING**

Following a start condition the master must output the address of the slave it is accessing. The most significant four bits of the slave are the device type identifier (see Figure 4). For the X24C02 this is fixed as 1010[B].

Figure 4. Slave Address



The next three significant bits address a particular device. A system could have up to eight X24C02 devices on the bus (see Figure 10). The eight addresses are defined by the state of the  $A_0$ ,  $A_1$  and  $A_2$  inputs.

The last bit of the slave address defines the operation to be performed. When set to one a read operation is selected, when set to zero a write operations is selected.

Following the start condition, the X24C02 monitors the SDA bus comparing the slave address being transmitted with its slave address (device type and state of  $A_0$ ,  $A_1$  and  $A_2$  inputs). Upon a correct compare the X24C02 outputs an acknowledge on the SDA line. Depending on the state of the R/W bit, the X24C02 will execute a read or write operation.

### WRITE OPERATIONS

### **Byte Write**

For a write operation, the X24C02 requires a second address field. This address field is the word address, comprised of eight bits, providing access to any one of the 256 words of memory. Upon receipt of the word address the X24C02 responds with an acknowledge, and awaits the next eight bits of data, again responding with an acknowledge. The master then terminates the transfer by generating a stop condition, at which time the X24C02 begins the internal write cycle to the nonvolatile memory. While the internal write cycle is in progress the X24C02 inputs are disabled, and the device will not respond to any requests from the master. Refer to Figure 5 for the address, acknowledge and data transfer sequence.

Figure 5. Byte Write

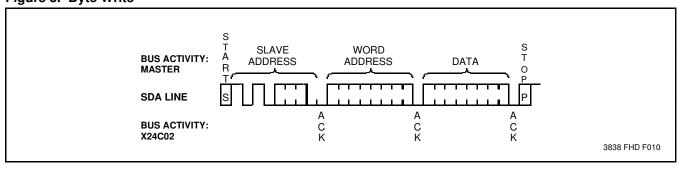
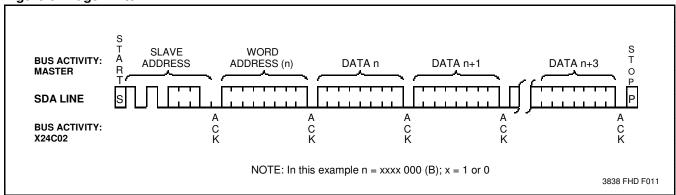


Figure 6. Page Write



#### **Page Write**

The X24C02 is capable of a four byte page write operation. It is initiated in the same manner as the byte write operation, but instead of terminating the write cycle after the first data word is transferred, the master can transmit up to three more words. After the receipt of each word, the X24C02 will respond with an acknowledge.

After the receipt of each word, the two low order address bits are internally incremented by one. The high order six bits of the address remain constant. If the master should transmit more than four words prior to generating the stop condition, the address counter will "roll over" and the previously written data will be overwritten. As with the byte write operation, all inputs are disabled until completion of the internal write cycle. Refer to Figure 6 for the address acknowledge and data transfer sequence.

### **Acknowledge Polling**

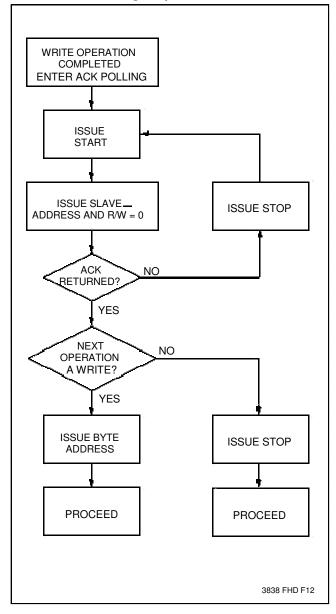
The disabling of the inputs, during the internal write operation, can be used to take advantage of the typical 5 ms write cycle time. Once the stop condition is issued to indicate the end of the host's write operation the X24C02 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the slave address for a write operation. If the X24C02 is still busy with the write operation no ACK will be returned. If the X24C02 has completed the write operation an ACK will be returned and the master can then proceed with the next read or write operation.

#### **READ OPERATIONS**

Read operations are initiated in the same manner as write operations with the exception that the R/W bit of the slave address is set to a one. There are three basic read operations: current address read, random read and sequential read.

It should be noted that the ninth clock cycle of the read operation is not a "don't care." To terminate a read operation, the master must either issue a stop condition during the ninth cycle or hold SDA HIGH during the ninth clock cycle and then issue a stop condition.

Flow 1. ACK Polling Sequence



#### **Current Address Read**

Internally the X24C02 contains an address counter that maintains the address of the last word accessed, incremented by one. Therefore, if the last access (either a read or write) was to address n, the next read operation would access data from address n + 1. Upon receipt of the slave address with the R/W bit set to one, the X24C02 issues an acknowledge and transmits the eight bit word during the next eight clock cycles. The master terminates this transmission by issuing a stop condition, omitting the ninth clock cycle acknowledge. Refer to Figure 7 for the sequence of address, acknowledge and data transfer.

#### Random Read

Random read operations allow the master to access any memory location in a random manner. Prior to issuing the slave address with the R/W bit set to one, the master must first perform a "dummy" write operation. The master ter issues the start condition, and the slave address followed by the word address it is to read. After the word address acknowledge, the master immediately reissues the start condition and the slave address with the R/W bit set to one. This will be followed by an acknowledge from the X24C02 and then by the eight bit word. The master terminates this transmission by issuing a stop condition, omitting the ninth clock cycle acknowledge. Refer to Figure 8 for the address, acknowledge and data transfer sequence.

Figure 7. Current Address Read

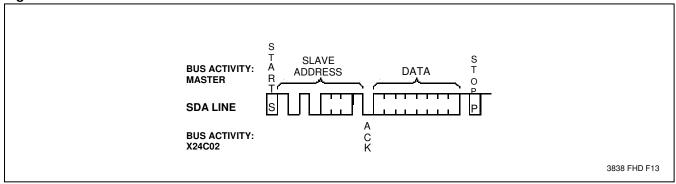
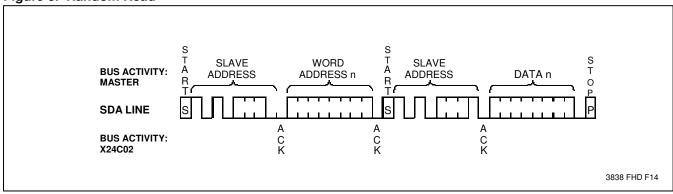


Figure 8. Random Read



#### Sequential Read

Sequential Read can be initiated as either a current address read or random access read. The first word is transmitted as with the other modes, however, the master now responds with an acknowledge, indicating it requires additional data. The X24C02 continues to output data for each acknowledge received. The master terminates this transmission by issuing a stop condition, omitting the ninth clock cycle acknowledge.

The data output is sequential, with the data from address and followed by the data from n+1. The address counter for read operations increments all address bits, allowing the entire memory contents to be serially read during one operation. At the end of the address space (address 255) the counter "rolls over" to address 0 and the X24C02 continues to output data for each acknowledge received. Refer to Figure 9 for the address, acknowledge and data transfer sequence.

Figure 9. Sequential Read

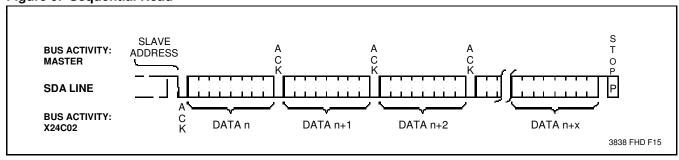
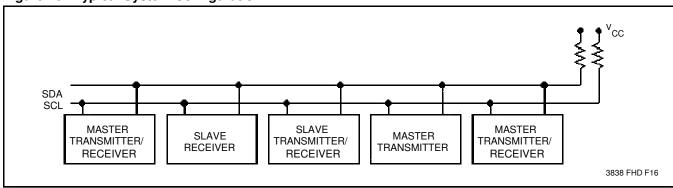


Figure 10. Typical System Configuration



#### **ABSOLUTE MAXIMUM RATINGS\***

Temperature Under Bias	65°C to +135°C
Storage Temperature	65°C to +150°C
Voltage on any Pin with	
Respect to V SS	1.0V to +7.0V
D.C. Output Current	5 mA
Lead Temperature (Solo	dering, 10 Seconds) 300°C

#### \*COMMENT

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions

for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.	
Commercial	0°C	70°C	
Industrial	-40°C	+85°C	
Military	–55°C	+125°C	

3838 PGM T09

Supply Voltage	Limits
X24C02	4.5V to 5.5V
X24C02-3.5	3.5V to 5.5V
X24C02-3	3V to 5.5V
X24C02-2.7	2.7 to 5.5V

3838 PGM T10

## D.C. OPERATING CHARACTERISTICS (Over recommended operating conditions unless otherwise specified).

		Limits		Limits			
Symbol	Parameter	Min.	Max.	Units	<b>Test Conditions</b>		
I <sub>CC1</sub>	Power Supply Current (read)		1	mA	SCL = V <sub>CC</sub> x 0.1/V <sub>CC</sub> x 0.9 Levels @ 100		
I <sub>CC2</sub>	Power Supply Current (write)		2		KHz, SDA = Open, All Other Inputs = GND or $V_{CC} - 0.3V$		
<b>I</b> <sub>SB</sub> <sup>(1)</sup>	Standby Current		50	∝A	$SCL = SDA = V_{CC} - 0.3V$ , All other		
					Inputs = GND or $V_{CC}$ , $V_{CC} = 5.5V$		
<sub>SB</sub> (2)	Standby Current		30	∝A	$SCL = SDA = V_{CC} - 0.3V$ , All Other		
					Inputs = GND or $V_{CC} = 3.3V + 10\%$		
ILI	Input Leakage Current		10	∝A	$V_{IN}$ = GND to $V_{CC}$		
I <sub>LO</sub>	Output Leakage Current		10	∝A	$V_{OUT} = GND$ to $V_{CC}$		
<b>V</b> <sub>IL</sub> (2)	Input Low Voltage	-1.0	V <sub>CC</sub> x 0.3	V			
<b>V</b> <sub>IH</sub> <sup>(2)</sup>	Input High Voltage	V <sub>CC</sub> x 0.7	V <sub>CC</sub> + 0.5	V			
V <sub>OL</sub>	Output Low Voltage		0.4	V	I <sub>OL</sub> = 3 mA		

3838 PGM T02

## **CAPACITANCE** $T_A = 25^{\circ}C$ , f = 1 MHz, $V_{CC} = 5V$

Symbol	Parameter		Units	Test Conditions
C <sub>I/O</sub> (3)	Input/Output Capacitance (SDA)	8	рF	$V_{I/O} = 0V$
C <sub>IN</sub> (3)	Input Capacitance (A <sub>0</sub> , A <sub>1</sub> , A <sub>2</sub> , SCL, WC)	6	pF	$V_{IN} = 0V$

3838 PGM T04

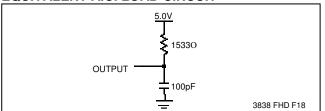
**Notes:**(1)Must perform a stop command prior to measurement. (2) $V_{IL}$  min. and  $V_{IH}$  max. are for reference only and are not tested. (3)This parameter is periodically sampled and not 100% tested.

## A.C. CONDITIONS OF TEST

Input Pulse Levels	V <sub>CC</sub> x 0.1 to V <sub>CC</sub> x 0.9		
Input Rise and Fall Times	10 ns		
Input and Output Timing Levels	V <sub>CC</sub> x 0.5		

3838 PGM T05

## **EQUIVALENT A.C. LOAD CIRCUIT**

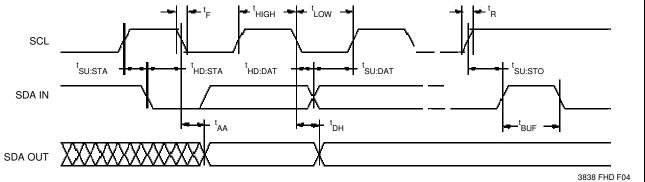


# **A.C. CHARACTERISTICS** (Over recommended operating conditions) **DATA INPUT TIMING**

Symbol	Parameter	Min.	Max.	Units
f <sub>SCL</sub>	SCL Clock Frequency	0	100	KHz
T <sub>I</sub>	Noise Suppression Time Constant at SCL, SDA Inputs		100	ns
t <sub>AA</sub>	SCL Low to SDA Data Out Valid	0.3	3.5	∝s
t <sub>BUF</sub>	Time the Bus Must Be Free Before a New Transmission Can Start	4.7		∝s
t <sub>HD:STA</sub>	Start Condition Hold Time	4.0		≪\$
t <sub>LOW</sub>	Clock Low Period	4.7		∝s
t <sub>HIGH</sub>	Clock High Period	4.0		≪S
t <sub>SU:STA</sub> Start Condition Setup Time		4.7		∝s
t <sub>HD:DAT</sub>	Data In Hold Time	0		≪\$
tsu:dat	Data In Setup Time	250		ns
t <sub>R</sub> SDA and SCL Rise Time			1	≪S
t⊨	t <sub>F</sub> SDA and SCL Fall Time t <sub>SU:STO</sub> Stop Condition Setup Time		300	ns
t <sub>SU:STO</sub>				∝s
t <sub>DH</sub>	Data Out Hold Time	300		ns

## **Bus Timing**

3838 PGM T06



## **POWER-UP TIMING**

Symbol Parameter		Max.	Units
t <sub>PUR</sub> (4)	t <sub>PUR</sub> <sup>(4)</sup> Power-up to Read Operation		ms
t <sub>PUW</sub> <sup>(4)</sup> Power-up to Write Operation		5	ms

3838 PGM T07

Notes:(4) tpuR and tpuW are the delays required from the time V<sub>CC</sub> is stable until the specified operation can be initiated. These parameters are periodically sampled and not 100% tested.

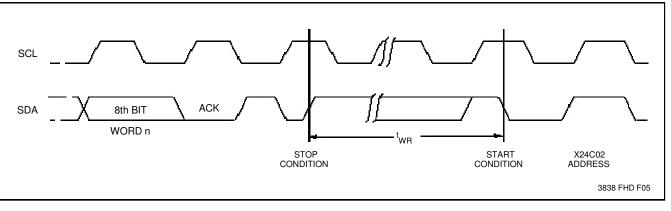
## WRITE CYCLE LIMITS

Symbol	Parameter	Min.	Typ. <sup>(5)</sup>	Max.	Units
t <sub>wR</sub> <sup>(6)</sup>	Write Cycle Time		5	. 10	ms

3838 PGM T08

The write cycle time is the time from a valid stop condition of a write sequence to the end of the internal erase/program cycle. During the write cycle, the X24C02 bus interface circuits are disabled, SDA is allowed to remain high, and the device does not respond to its slave address.

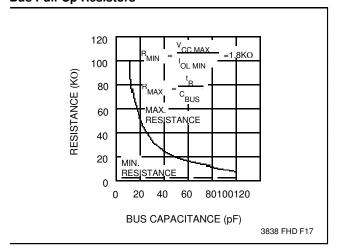
## Write Cycle Timing



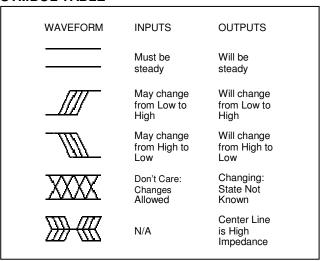
**Notes:** (5) Typical values are for  $T_A = 25$  C and nominal supply voltage (5V)

(6) t<sub>WR</sub> is the minimum cycle time from the system perspective when polling techniques are not used. It is the maximum time the device requires to perform the internal write operation.

# Guidelines for Calculating Typical Values of Bus Pull-Up Resistors

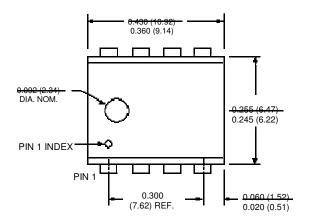


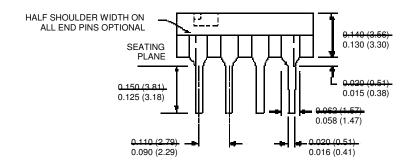
#### **SYMBOL TABLE**

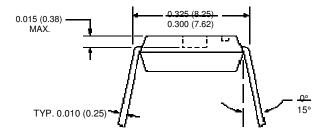


## **PACKAGING INFORMATION**

## 8-LEAD PLASTIC DUAL IN-LINE PACKAGE TYPE P



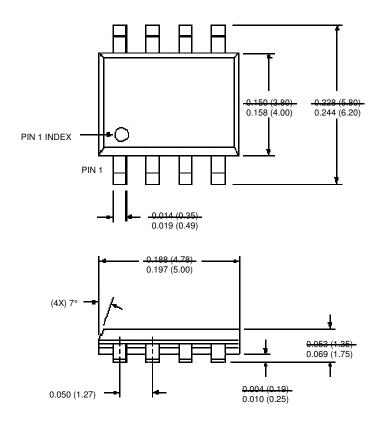


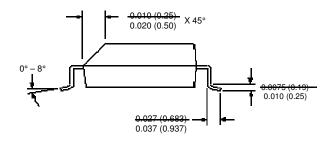


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

## **PACKAGING INFORMATION**

## 8-LEAD PLASTIC SMALL OUTLINE GULL WING PACKAGE TYPE S

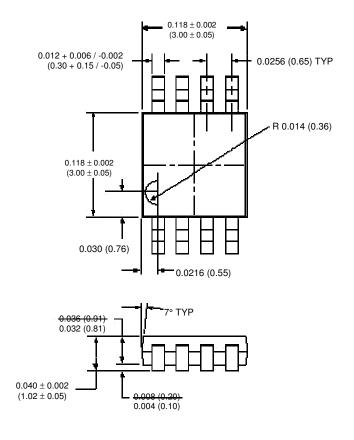


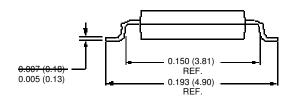


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESIS IN MILLIMETERS)

## **PACKAGING INFORMATION**

## 8-LEAD MINIATURE SMALL OUTLINE GULL WING PACKAGE TYPE M





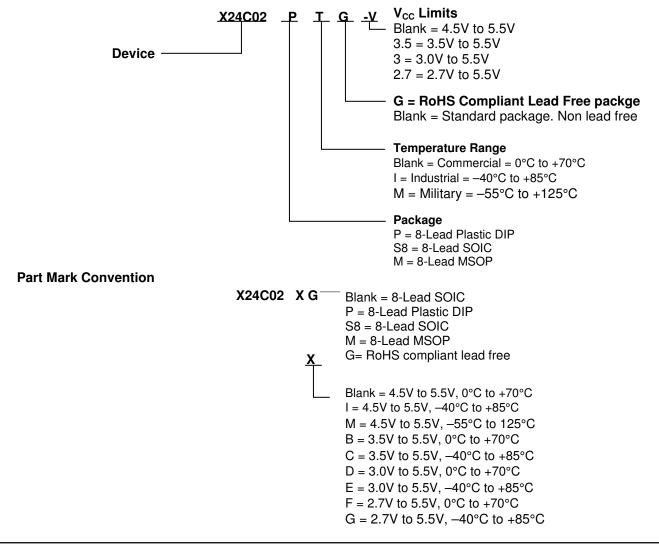
#### NOTE:

1. ALL DIMENSIONS IN INCHES AND (MILLIMETERS)

3003 ILL 01

## **NOTES**

### ORDERING INFORMATION



#### LIMITED WARRANTY

Devices sold by Xicor, Inc. are covered by the warranty and patent indemnification provisions appearing in its Terms of Sale only. Xicor, Inc. makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Xicor, Inc. makes no warranty of merchantability or fitness for any purpose. Xicor, Inc. reserves the right to discontinue production and change specifications and prices at any time and without notice.

Xicor, Inc. assumes no responsibility for the use of any circuitry other than circuitry embodied in a Xicor, Inc. product. No other circuits, patents, licenses are implied.

#### U.S. PATENTS

Xicor products are covered by one or more of the following U.S. Patents: 4,263,664; 4,274,012; 4,300,212; 4,314,265; 4,326,134; 4,393,481; 4,404,475; 4,450,402; 4,486,769; 4,488,060; 4,520,461; 4,533,846; 4,599,706; 4,617,652; 4,668,932; 4,752,912; 4,829, 482; 4,874, 967; 4,883, 976. Foreign patents and additional patents pending.

#### LIFE RELATED POLICY

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurence.

Xicor's products are not authorized for use in critical components in life support devices or systems.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## О компании

ООО "ТрейдЭлектроникс" - это оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов. Реализуемая нашей компанией продукция насчитывает более полумиллиона наименований.

Благодаря этому наша компания предлагает к поставке практически не ограниченный ассортимент компонентов как оптовыми, мелкооптовыми партиями, так и в розницу.

Наличие собственной эффективной системы логистики обеспечивает надежную поставку продукции по конкурентным ценам в точно указанные сроки.

Срок поставки со стоков в Европе и Америке – от 3 до 14 дней.

Срок поставки из Азии - от 10 дней.

Благодаря развитой сети поставщиков, помогаем в поиске и приобретении экзотичных или снятых с производства компонентов.

Предоставляем спец цены на элементы для создания инженерных сэмплов.

Упорный труд, качественный результат дают нам право быть уверенными в себе и надежными для наших клиентов.

## Наша компания это:

- Гарантия качества поставляемой продукции
- Широкий ассортимент
- Минимальные сроки поставок
- Техническая поддержка
- Подбор комплектации
- Индивидуальный подход
- Гибкое ценообразование

Наша организация особенно сильна в поставках модулей, микросхем, пассивных компонентов, ксайленсах (XC), EPF, EPM и силовой электроники.

Большой выбор предлагаемой продукции, различные виды оплаты и доставки, позволят Вам сэкономить время и получить максимум выгоды от сотрудничества с нами!



## <u>Перечень производителей, продукцию которых мы поставляем</u> на российский рынок























































































































**Panasonic** 



RENESAS





**SIEMENS** 













гарантия бесперебойности производства и качества выпускаемой продукции

С удовольствием будем прорабатывать для Вас поставки всех необходимых компонентов по текущим запросам для скорейшего выявления групп элементов, по которым сотрудничество именно с нашей компанией будет для Вас максимально выгодным!

С уважением,
Менеджер отдела продаж ООО
«Трейд Электроникс»
Шишлаков Евгений
8 (495)668-30-28 доб 169
manager28@tradeelectronics.ru

http://www.tradeelectronics.ru/